



# MOS FIELD EFFECT TRANSISTOR **2SK2983**

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

## DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for high current switching application.

## FEATURES

- Low on-resistance  $R_{DS(on)1} = 20 \text{ m}\Omega \text{ (MAX.)} \text{ (Vgs} = 10 \text{ V, Id} = 15 \text{ A)}$  $R_{DS(on)2} = 27 \text{ m}\Omega \text{ (MAX.)} \text{ (Vgs} = 4.5 \text{ V, Id} = 15 \text{ A)}$
- Low Ciss Ciss = 1200 pF TYP.
- Built-in gate protection diode

## ORDERING INFOMATION

PART NUMBER	PACKAGE	- 3ª 3ª
2SK2983	TO-220AB	32 3
2SK2983-S	TO-262	132 -011-
2SK2983-ZJ	TO-263	

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage <sup>Note1</sup>	Vdss	30	V
Gate to Source Voltage <sup>Note2</sup>	Vgss	±20	V
Drain Current (DC)	ID(DC)	±30	А
Drain Current (pulse) <sup>Note3</sup>	D(pulse)	±120	А
Total Power Dissipation (TA = $25^{\circ}$ C)	P⊤	1.5	W
Total Power Dissipation (Tc = 25°C)	Рт	50	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C

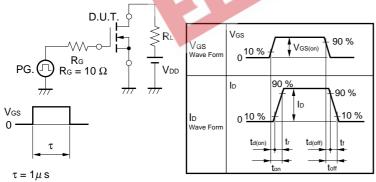
- Notes1. VGS = 0 V
  - **2.** VDS = 0 V
  - **3.** PW  $\leq$  10  $\mu$  s, Duty Cycle  $\leq$  1 %

The information in this document is subject to change without notice.

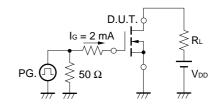
ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 15 A		13.0	20.0	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 15 A		18.0	27.0	mΩ
Gate to Source Cut-off Voltage	VGS(off)	Vds = 10 V, Id = 1 mA	1.0	1.5	2.0	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A	9.0	19		S
Drain Leakage Current	loss	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		1200		pF
Output Capacitance	Coss	Vgs = 0 V		530		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		250		pF
Turn-on Delay Time	td(on)	ID = 15 A		50		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		820		ns
Turn-off Delay Time	td(off)	$V_{DD} = 15 V$		100		ns
Fall Time	tr	R <sub>G</sub> = 10 Ω		170		ns
Total Gate Charge	QG	ID = 30 A		30		nC
Gate to Source Charge	Q <sub>GS</sub>	$V_{DD} = 24 V$ $V_{GS} = 10 V$ $I_F = 30 A, V_{GS} = 0 V$ $I_F = 30 A, V_{GS} = 0 V$ $di/dt = 100 A / \mu S$	8	4.5		nC
Gate to Drain Charge	Qgd		D.	7.5		nC
Body Diode Forward Voltage	VF(S-D)	IF = 30 A, VGS = 0 V	11-	0.8		V
Reverse Recovery Time	trr	IF = 30 A, VGS = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A /µS		65		nC

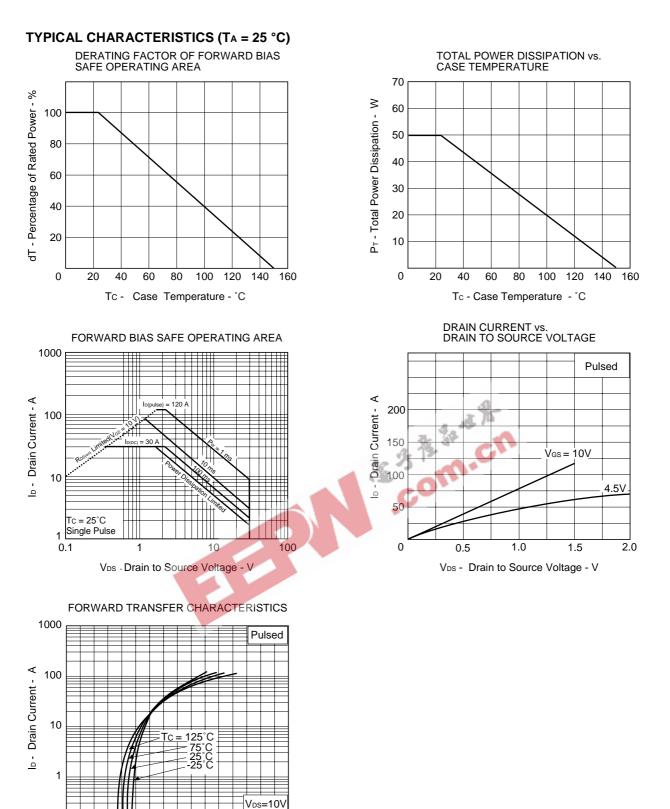
## TEST CIRCUIT 1 SWITCHING TIME



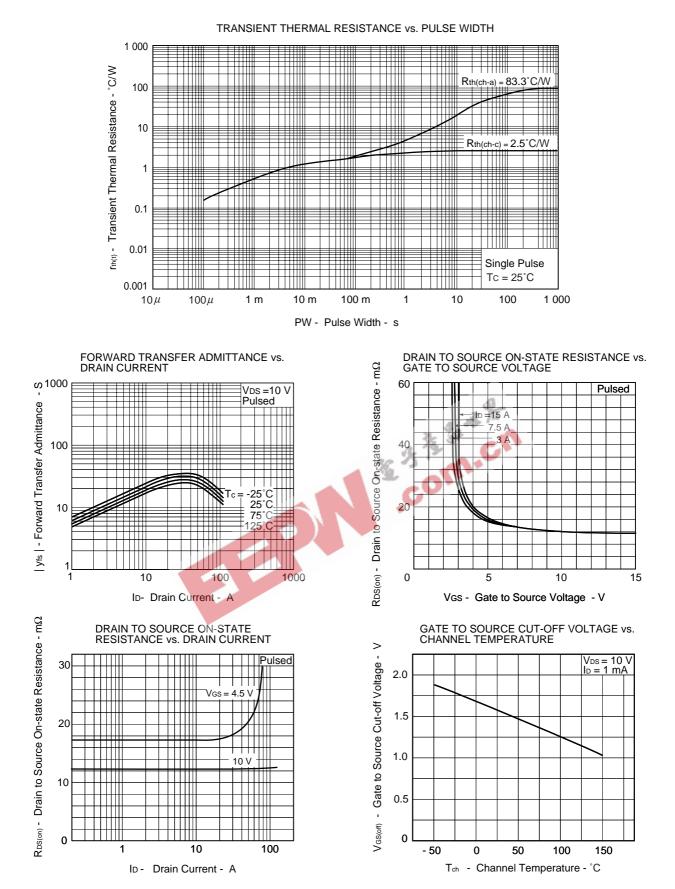
### **TEST CIRCUIT 2 GATE CHARGE**



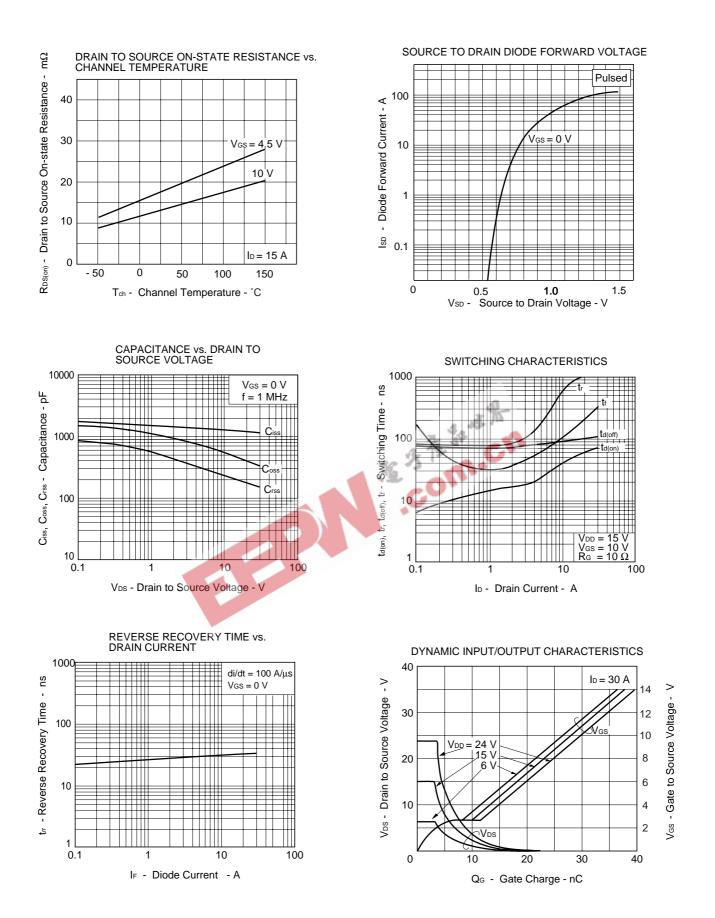
Duty Cycle  $\leq$  1 %







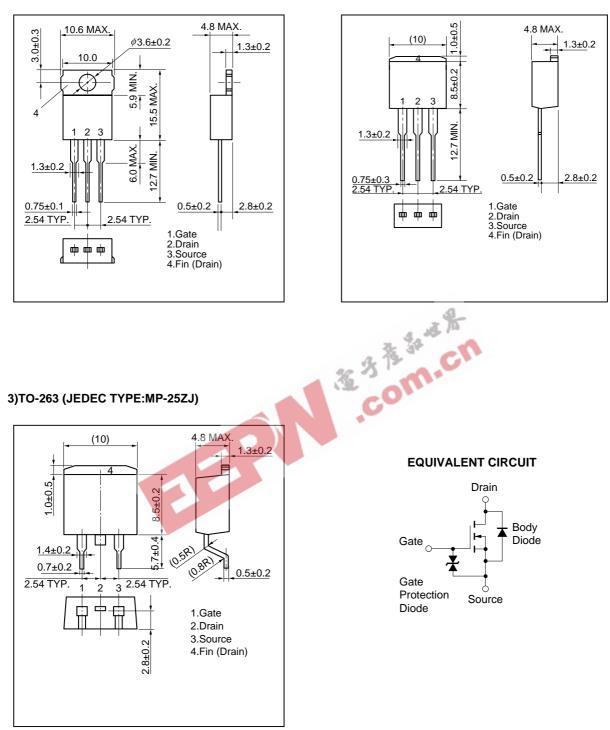
4



2)TO-262 (TO-220 Fin Cut:MP-25S)

## PACKAGE DRAWINGS (Unit : mm)

### 1)TO-220AB (MP-25)



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device [MEMO]



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Anti-radioactive design is not implemented in this product.

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